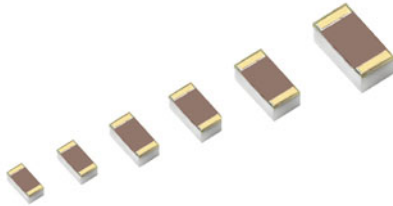


Ultra High Precision Z1-Foil Technology Chip Resistor for Hybrid Circuits with Aluminum Wire Bonding for High Temperature Applications up to +240°C, Long Term Stability of 0.05%, TCR to $\pm 1\text{ppm}/^\circ\text{C}$



INTRODUCTION

Vishay Foil Resistors (VFR) introduces a new line of Ultra Precision Bulk Metal[®] Z1-Foil technology: chip resistor for hybrid circuits with aluminum wire bonding. These new types of hybrid chips were especially designed for high temperature applications up to +240 °C⁽¹⁾ (working power: to 150mW at +220°C), and include gold plated terminals.

The HTHA series is available in any value within the specified resistance range. VFR's application engineering department is available to advise and make recommendations.

For non-standard technical requirements and special applications, please contact foil@vishaypg.com.

TABLE 1 - TOLERANCE AND TCR VS. RESISTANCE VALUE (1)(2) (- 55 °C to + 220 °C, + 25 °C Ref.)		
RESISTANCE VALUE (Ω)	TOLERANCE (%)	TCR Typical (ppm/°C)
100 to 125K	± 0.02	± 2.5
50 to < 100	± 0.05	
25 to < 50	± 0.1	
10 to < 25	± 0.25	
5 to 10	± 0.5	

Note

- (1) Performances obtained with ceramic PCB.
(2) For tighter performances or non-standard values up to 150 kΩ, please contact VFR's application engineering department by sending an e-mail to the address in the footer below.

FEATURES

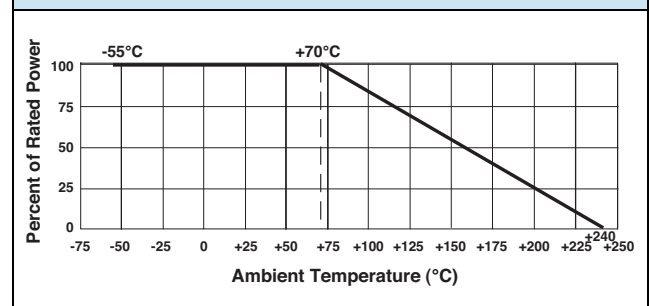
- Temperature coefficient of resistance (TCR): $\pm 1\text{ppm}/^\circ\text{C}$ typical (- 55 °C to + 125 °C, + 25 °C ref.) $\pm 2.5\text{ppm}/^\circ\text{C}$ typical (- 55 °C to + 220 °C, + 25 °C ref.)
- Resistance range: 5 Ω to 125 kΩ (for higher or lower values, please contact VFR's application engineering department)
- Resistance tolerance: to $\pm 0.02\%$
- **Connection method: aluminum wire bonding***
- **Working power: to 150mW at + 220°C**
- **Long term stability: to $\pm 0.05\%$ at + 240°C for 2000h, no power**
- **Load life stability: to 0.05% at + 220°C for 2000h at working power**
- Vishay Foil resistors are not restricted to standard values; specific "as required" values can be supplied at no extra cost or delivery (e.g. 1K2345 vs. 1K)
- Thermal stabilization time < 1 s (nominal value achieved within 10 ppm of steady state value)
- Electrostatic discharge (ESD) at least to 25 kV
- Non inductive, non capacitive design
- Rise time: 1 ns effectively no ringing
- Current noise: 0.010 μV (RMS)/Volt of applied voltage (< - 40 dB)
- Voltage coefficient: < 0.1 ppm/V
- Non inductive: < 0.08 μH
- Non hot spot design
- Terminal finish available: gold plated (lead (Pb)-free alloy)
- Prototype quantities available in just 5 working days or sooner. For more information, please contact foil@vishaypg.com



RoHS
COMPLIANT

* For other mounting option: facing down (flip chip) mounted by electrical conductive-epoxy please contact application engineering department

FIGURE 1 - POWER DERATING CURVE



HIGH TEMPERATURE PRODUCTS

Resistors are the passive building blocks of an electrical circuit. They may be used for dropping the voltage, buffering the surge when the circuit is turned on, providing feedback in a monitoring loop, sensing current flow, etc. When the application requires stability over time and load, initial accuracy, minimal change with temperature for more than 200 °C, resistance to moisture and a number of other characteristics that will be described, only the new generation of Vishay Foil Resistors have the attributes needed for this application. Over the past few months, there has been considerable growth in the demand for precise, stable and reliable resistors that can operate in harsh environments and especially at high temperatures to 220 °C. Many analog circuits for industrial, military, aerospace, medical, down-hole, oil well and automotive applications require passive components such as resistors to have a minimal drift from their initial values when operating above + 175 °C and in humid environments. In these applications, the most important factor is the end of life tolerance (which is part of the stability) and to a lesser extent, the initial tolerance.

The new Vishay Foil resistors provide stabilities well under the maximum allowable drift required by customers' specifications through thousands of hours of operation under harsh conditions, such as the extreme temperatures and radiation-rich environments of down-hole oil-well logging applications, in the frigid arctic, under the sea or in deep space. All Bulk Metal[®] Foil resistors receive stabilization processing, such as repetitive short term power overloads, to assure reliable service through the unpredictable stresses of extreme operation. Compared to Bulk Metal[®] Foil, thick and thin film resistor elements are produced with a non-controllable material. Heat or mechanical stresses on the resistive elements cause the particles forming the film to expand. However, after these stresses are alleviated, the particles in the film matrix do not return to the exact original position. That degenerates their overall stability.

Vishay Foil Resistors' Ultra High Precision Bulk Metal[®] Foil technology includes many types of resistors with a variety of standard configurations that can withstand unconventional environmental conditions above and below the earth's surface using special post manufacturing operations specially developed for this purpose. The stability of a resistor depends primarily on its history of exposures to high temperature. Stability is affected by:

1. Changes in the ambient temperature and heat from adjacent components (defined by the Temperature Coefficient of Resistance, or TCR)
2. Destabilizing thermal shock of suddenly-applied power (defined by the Power Coefficient of Resistance, or PCR)
3. Long-term exposure to applied power (load-life stability)
4. Repetitive stresses from being switched on and off

In very high-precision resistors that need to operate in an environment with temperatures above + 175 °C, these effects must be taken into account to achieve high stability with changes in load (Joule Effect) and ambient temperature.

The Bulk Metal[®] Foil Resistors' new Z1-Foil technology provides an order of magnitude reduction in the Bulk Metal[®] Foil element's sensitivity to temperature changes — both external and internal – with emphasis on long term stability in high temperature environments.

In order to take full advantage of the low TCR and long term stability improvement, it is necessary to take into account the differences in the resistor's response to each of the above-mentioned effects. As described below, new products have been developed to successfully deal with these factors. For high temperature applications where stability and total error budget is the main concern, the new generation of Vishay Foil resistors offers the best resilience against time at elevated temperature.

The new Vishay Foil technology allows us to produce customer-oriented products designed to satisfy unique and specific technical requirements. In addition to the special chip stabilization under extreme environment conditions in the production line, we offer additional specially oriented post manufacturing operations (PMO) for high temperature applications that require an even higher degree of reliability and stability.

Electrostatic Discharge (ESD) is another potential problem that can cause unpredictable failure in high temperature applications that increase the sensitivity of the resistors to ESD.

ESD damage to electronic devices can occur at any point in the device's life cycle, from manufacturing to field service. A resistor that is exposed to an ESD event may fail immediately or may experience a latent defect. With latent defects, premature failure can occur after the resistor is already functioning in the finished product after an unpredictable length of service. Bulk Metal[®] Foil resistors are capable of withstanding electrostatic discharges at least to 25 kV volts without degradation.

VFR's Application Engineering department is always available to assist with any special requirements you might have. If you are not sure which resistor best suits your needs, please do not hesitate to contact them for more information: Foil@vishaypg.com

TABLE 2 - PRODUCT SPECIFICATIONS

PRODUCT	CONNECTING METHOD*	SIZES
HTHA	Aluminum wire bonding	0603,0805,1206, 1506,2010,2512

* The HTHA series can also act as a surface mount (flip chip—facing down) and to be mounted using electrical conductive epoxy. For more information, please contact application engineering department.

TABLE 3 - SPECIFICATIONS

CHIP SIZE	WORKING POWER (mW) at + 220 °C ⁽¹⁾	RESISTANCE RANGE (Ω)
0603	12.5	100 to 5K
0805	20	5 to 8K
1206	33	5 to 25K
1506	40	5 to 30K
2010	100	5 to 70K
2512	150	5 to 125K

Note

⁽¹⁾ Maximum working voltage at +220°C for a given resistance value is calculated using $V = \sqrt{P \times R}$.

FIGURE 2 - TRIMMING TO VALUES (Conceptual Illustration)

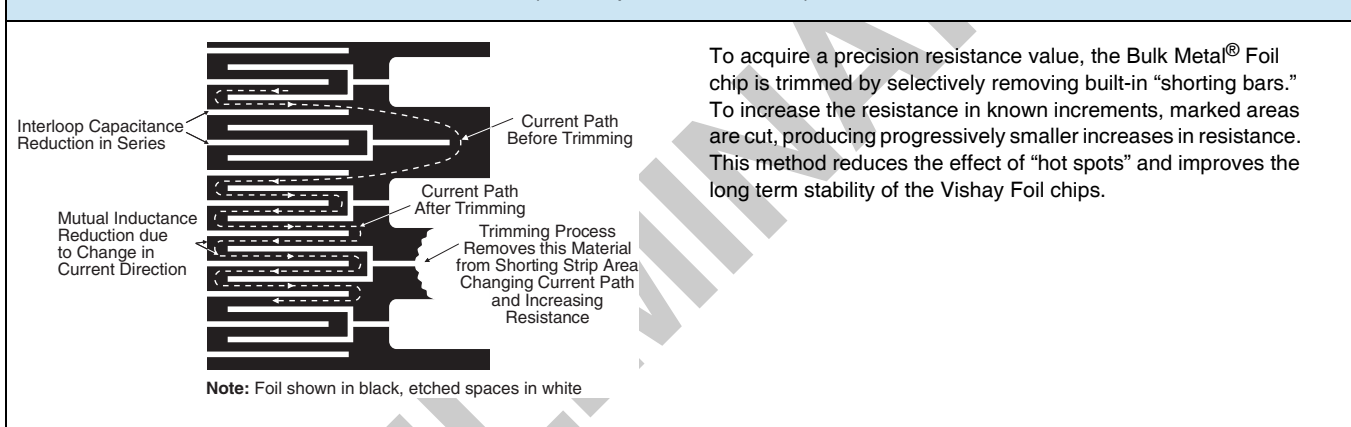
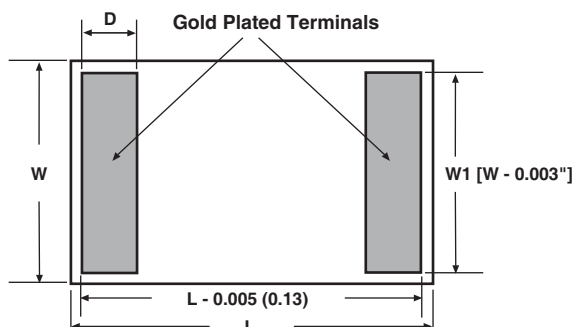


TABLE 4 - DIMENSIONS in inches (millimeters)*



CHIP SIZE	L ± 0.005 (0.13)	W ± 0.005 (0.13)	THICKNESS MAXIMUM	D NOMINAL
0603	0.063 (1.60)	0.032 (0.81)	0.025 (0.64)	0.006 (0.15)
0805	0.079 (2.01)	0.049 (1.24)	0.025 (0.64)	0.010 (0.25)
1206	0.126 (3.20)	0.062 (1.57)	0.025 (0.64)	0.015 (0.38)
1506	0.150 (3.81)	0.062 (1.57)	0.025 (0.64)	0.012 (0.30)
2010	0.200 (5.08)	0.100 (2.54)	0.025 (0.64)	0.020 (0.51)
2512	0.250 (6.35)	0.126 (3.20)	0.025 (0.64)	0.024 (0.61)

*** Notes**

- Avoid the use of cleaning agents that could attack epoxy resins, which form part of the resistor construction
- Vacuum pick up is recommended for handling

TABLE 5 - COMPARATIVE PERFORMANCES⁽¹⁾ - THIN FILM VS. BULK METAL[®] Z1-FOIL TECHNOLOGY

TEST OR CONDITIONS	ΔR LIMITS OF THIN FILM (TYPICAL)	ΔR LIMITS OF BULK METAL [®] Z1-FOIL TECHNOLOGY - HTHA SERIES ⁽²⁾ (TYPICAL)
Thermal Shock, 5 x (- 65 °C to + +220 °C)	± 0.1 %	± 0.03% (300 ppm)
Low Temperature Operation, - 65 °C, 45 min at Rated Power	± 0.1 %	± 0.0025% (25 ppm)
Moisture Resistance	± 0.1 %	± 0.003% (30 ppm)
Load Life Stability, + 220 °C for 2000 h at working power (see table 3)	± 0.5 %	± 0.05% (500 ppm)
Long term stability, + 240 °C for 2000h, no power	± 0.5 %	± 0.05% (500 ppm)

Note

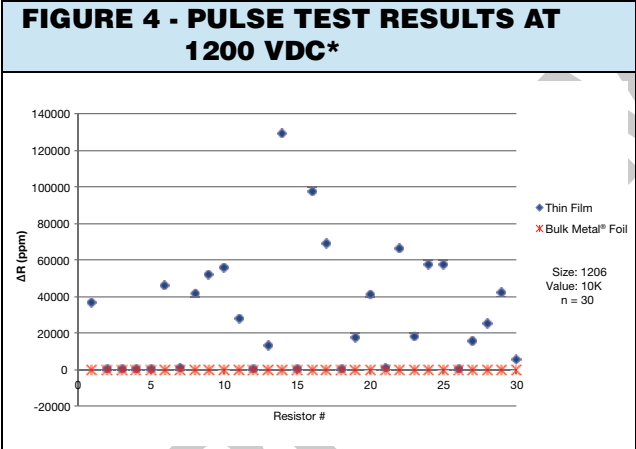
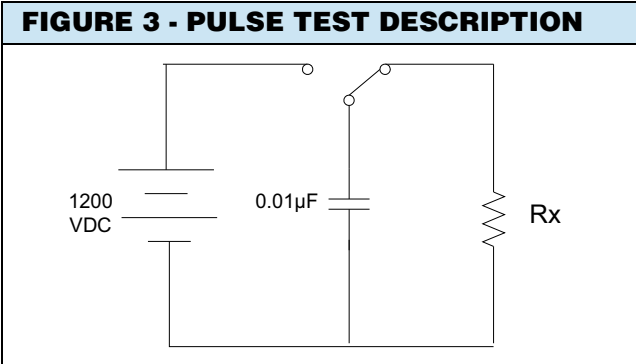
- (1) As shown + 0.01 Ω to allow for measurement errors at low values.
 (2) Performances obtained with ceramic PCB.

PULSE TEST

TEST DESCRIPTION

All parts are baked at +125°C for 1 hour and allowed to cool at room temperature for 1 hour, prior to testing. By using an electrolytic 0.01 μF capacitor charged to 1200 VDC, a single pulse was performed on 30 units of 1206, 10 kΩ of Surface Mount Vishay Foil resistor and Thin Film resistor. The unit was allowed time to cool down, after which the resistance measurement was taken and displayed in ppm deviation from the initial reading.

TEST RESULTS



* Note: Average of 30 units yielded deviation of 30,723 ppm for the Thin Film vs. -14 ppm for the Bulk Metal[®] Foil

ELECTROSTATIC DISCHARGE (ESD)

ESD can be categorized into three types of damages:

Parametric Failure - occurs when the ESD event alters one or more device parameters (resistance in the case of resistors), causing it to shift from its required tolerance. This failure does not directly pertain to functionality; thus a parametric failure may be present while the device is still functional.

Catastrophic Damage - occurs when the ESD event causes the device to immediately stop functioning. This may occur after one or a number of ESD events with diverse causes, such as human body discharge or the mere presence of an electrostatic field.

Latent Damage - occurs when the ESD event causes moderate damage to the device, which is not noticeable, as the device appears to be functioning correctly. However, the load life of the device has been dramatically reduced, and further degradation caused by operating stresses may cause the device to fail during service. Latent damage is the source for greatest concern, since it is very difficult to detect by re-measurement or by visual inspection, because damage may have occurred under the external coating.

TEST DESCRIPTION

By using an electrolytic 500 pF capacitor charged up to 4500 V, pulses were performed on 10 units of 1206, 10 kΩ of three different Surface Mount Chip Resistors technologies, with an initial voltage spike of 2500 V (Figure 5). The unit was allowed time to cool down, after which the resistance measurement was taken and displayed in ppm deviation from the initial reading. Readings were then taken in 500 V increments up to 4500 V.

TEST RESULTS

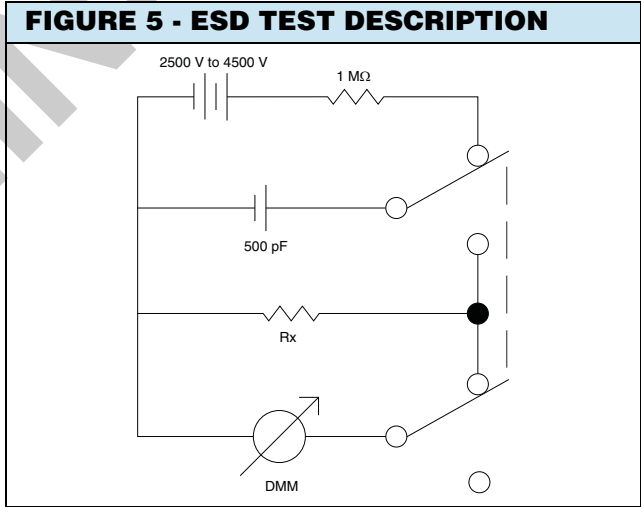


TABLE 6 - ESD TEST RESULTS

VOLTS	ΔR (%)		
	THICK FILM	THIN FILM	FOIL
2500	-2.7	97	<0.005
3000	-4.2	366	<0.005
3500	-6.2	>5000	<0.005
4000	-7.4	>5000	<0.005
4500	-8.6	OPEN	<0.005

TABLE 7 - GLOBAL PART NUMBER INFORMATION (1)														
NEW GLOBAL PART NUMBER: Y077712K7560Q0W (preferred part number format)														
DENOTES PRECISION Y			VALUE R = Ω K = $k\Omega$				CHARACTERISTICS 0 = standard (gold plated) 1 to 999 = custom							
Y	0	7	7	7	1	2	K	7	5	6	0	Q	0	W
PRODUCT CODE 0774 = HTHA0603 0775 = HTHA0805 0776 = HTHA1206 0777 = HTHA1506 0778 = HTHA2010 0779 = HTHA2512				RESISTANCE TOLERANCE Q = $\pm 0.02\%$ A = $\pm 0.05\%$ B = $\pm 0.10\%$ C = $\pm 0.25\%$ D = $\pm 0.5\%$ F = $\pm 1.0\%$				PACKAGING W = waffle pack						
FOR EXAMPLE: ABOVE GLOBAL ORDER Y0777 12K7560 Q 0 W: TYPE: HTHA1506 VALUES: 12.7560 $k\Omega$ ABSOLUTE TOLERANCE: 0.02 % TERMINATION: standard (gold plated) PACKAGING: waffle pack														
HISTORICAL PART NUMBER: HTHA1506 12K756 Q W (WILL CONTINUE TO BE USED)														
HTHA1506			12K756			Q			W					
MODEL			RESISTANCE VALUE			TOLERANCE			PACKAGING					
0774 = HTHA0603 0775 = HTHA0805 0776 = HTHA1206 0777 = HTHA1506 0778 = HTHA2010 0779 = HTHA2512			12.756 $k\Omega$			Q = $\pm 0.02\%$ A = $\pm 0.05\%$ B = $\pm 0.10\%$ C = $\pm 0.25\%$ D = $\pm 0.5\%$ F = $\pm 1.0\%$			W = waffle pack					

Note

(1) For non-standard requests, please contact application engineering.

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